ISSOCIATION CON LECTRONICS IND	© Copyright 2005. international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This docu level part	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
52-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					Ifg Informati	on		
applier In	formation													
Company name* Company unique ID				nique ID	Unique ID Authority				Response Date*					
semi			!								2023-06-08			
ontact Name	•		Title - Contact			Phone - Contact*				Email -	Email - Contact*			
roduct-Env-	Stewards		Product Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title				Fitle - Representative			Phone - Representative*			Email -	Email - Representative*			
Product-Env-Stewards Product Env				nviro Compliance		NA	NA			Product-Env-Stewards@onsemi.com				
Re	equester Item Number	Mfr Iten	n Number	Mfr Item Name		Effective D	ate Ve	rsion	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP1075AAP065G Enhanced Off-line Switcher Protections and Power Capa			2023-06-08			CNW		471.77	mg	Each		
[anufactu	ring Proccess Informa	tion												
Ten	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-020		-STD-020 MSL Rating	Peak Process Body Temperature Max Time at P		ire Max Time at Peal	k Tempera	ture Numb	er of Reflow Cyc	eles		
Matte Tin (Sn) - annealed		(	CU Alloy NA		IA .	0	C 30		secon	nds 3				
omments														

RoHS Material Composition Declaration			Declaration Type *	Detail	led
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an		
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the co	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit iden you believe may apply. If the part is an assemble is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the hts and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.19	mg	Supplier	Silicon (Si)	7440-21-3		2.19	mg
Die Attach	8.92	mg	Supplier	Silver (Ag)	7440-22-4		6.69	mg
			Supplier	Epoxy resins	129915-35-1		2.23	mg
Lead Frame	131.05	mg	Supplier	Silver (Ag)	7440-22-4		0.9173	mg
			Supplier	Zinc (Zn)	7440-66-6		0.2621	mg
			Supplier	Iron (Fe)	7439-89-6		3.4073	mg
			Supplier	Copper (Cu)	7440-50-8		126.4632	mg
Mold Compound-Black	317.53	mg		Epoxy resin	proprietary data		15.8765	mg
			Supplier	Phenolic Resin	Proprietary Data		15.8765	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.3506	mg
			Supplier	Carbon Black (C)	1333-86-4		1.5876	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		277.8387	mg
Plating	11.9	mg	Supplier	Tin (Sn)	7440-31-5		11.9	mg
Wire Bond	0.18	mg	Supplier	Palladium (Pd)	7440-05-3		0.0018	mg
			Supplier	Copper (Cu)	7440-50-8		0.1782	mg